**PATENT ASSIGNMENT**

**SUBMISSION TYPE:** NEW ASSIGNMENT

**NATURE OF CONVEYANCE:** ASSIGNMENT

### CONVEYING PARTY DATA

<table>
<thead>
<tr>
<th>Name</th>
<th>Execution Date</th>
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<tr>
<td>Tadahiko Kawabe</td>
<td>11/21/2007</td>
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### RECEIVING PARTY DATA

<table>
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<tr>
<th>Name</th>
<th>NGK Spark Plug Co., LTD.</th>
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</thead>
<tbody>
<tr>
<td>Street Address</td>
<td>14-18, Takatsuji</td>
</tr>
<tr>
<td>Internal Address</td>
<td>Mizuho-ku, Nagoya</td>
</tr>
<tr>
<td>City</td>
<td>Aichi</td>
</tr>
<tr>
<td>State/Country</td>
<td>JAPAN</td>
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**PROPERTY NUMBERS Total: 1**

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<td>Application Number</td>
<td>11944784</td>
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**CORRESPONDENCE DATA**

Fax Number: (440)684-1095

*Correspondence will be sent via US Mail when the fax attempt is unsuccessful.*

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Email: lcahill@kusnerjaffe.com

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Address Line 4: HIGHLAND HEIGHTS, OHIO 44143

**ATTORNEY DOCKET NUMBER:** NG9571US

**NAME OF SUBMITTER:** Michael A. Jaffe

Total Attachments: 1

source=NG9571US-Assignment#page1.tif
ASSIGNMENT OF INVENTION

In consideration of the payment by ASSIGNEE to ASSIOR of the sum of One Dollar ($1.00), the receipt of which is hereby acknowledged, and for other good and valuable consideration,

ASSIGNORS:
Tadahiko Kawabe
7-95, Satsukigaoka
Kani, Gifu
JAPAN
Nationality: Japan

hereby sell, assign and transfer to

ASSIGNEE:
NGK Spark Plug Co., LTD.
14-18, Takatsuji
Mizuho-ku, Nagoya
Aichi, JAPAN

Country of Formation: Japan

and the successors, assigns and legal representatives of the ASSIGNEE the entire right, title and interest for the United States and its territorial possessions in and to any and all improvements which are disclosed in the invention entitled:

MULTILAYER WIRING BOARD AND POWER SUPPLY STRUCTURE TO BE EMBEDDED IN MULTILAYER WIRING BOARD

and which is found in (37 C.F.R. Section 3.21) and, in and to, all Letters Patent to be obtained for said invention by the above application or any continuation, division, renewal, or substitute thereof, and as to letters patent any reissue or re-examination thereof.

ASSIGNOR hereby covenant that no assignment, sale, agreement or encumbrance has been or will be made or entered into which would conflict with this assignment.

ASSIGNOR further covenant that ASSIGNEE will, upon their request, be provided promptly with all pertinent facts and documents relating to said invention and said Letters Patent and legal equivalents as may be known and accessible to ASSIGNOR and will testify as to the same in any interference, litigation or proceeding related thereto and will promptly execute and deliver to ASSIGNEE or their legal representatives any and all papers, instruments or affidavits required to apply for, obtain, maintain, issue and enforce said application, said invention and said Letters Patent and said equivalents thereof which may be necessary or desirable to carry out the purposes thereof.

IN WITNESS WHEREOF, We have hereunto set hand and seal on the date(s) set forth below.

Date: 11/21/2007

[Signature]

Assignment of Invention—page 1 of 1